



SBR2A40P1Q

2.0A SBR SURFACE MOUNT SUPER BARRIER RECTIFIER

Product Summary (@ T_A = +25°C)

V _{RRM} (V)	I _O (A)	V _F Max (V) @ 2A	I _R Max (μA) @ 40V
40	2	0.50	100

Description & Applications

Packaged in the compact thermally efficient PowerDI®123. SBR2A40P1Q provides low V_F and low reverse leakage at high temperatures. It is ideal for use in the following applications:

- Bridge Diodes
- **Freewheeling Diodes**
- **Blocking Diodes**
- **Reverse Protection Diodes**

Features and Benefits

- Low Forward Voltage Drop
- Low Leakage Current
- Superior Reverse Avalanche Capability
- **Excellent High-Temperature Stability**
- Patented Interlocking Clip Design for High-Surge Current Capacity
- Patented Super Barrier Rectifier Technology (SBR[®])
- Soft, Fast Switching Capability
- +150°C Operating Junction Temperature
- ±16KV ESD Protection (HBM, 3B)
- ±25KV ESD Protection (IEC61000-4-2 Level 4, Air Discharge)
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

Mechanical Data

- Case: PowerDI123
- Case Material: Molded Plastic, "Green" Molding Compound; UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Polarity Indicator: Cathode Band
- Terminals: Finish Matte Tin Annealed over Copper Leadframe; Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.018 grams (Approximate)



PowerDI123

Top View

Ordering Information (Notes 5 & 6)

Part Number	Compliance	Case	Packaging
SBR2A40P1Q-7	Automotive	PowerDI123	3,000/Tape & Reel

1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied. Notes: 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

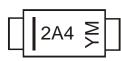
4. Automotive products are AEC-Q101 gualified and are PPAP capable. Refer to https://www.diodes.com/guality/.

5. Product manufactured with Date Code F7 (July, 2018) and newer are built with Green Molding Compound.

6. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information

PowerDI123	
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2A4 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: F = 2018)M = Month (ex: 9 = September)

Date Code Kev

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Year	2006	~	2015	2016	6 20 ′	17 2	018	2019	2020	2021	2022	2023
Code	Т	~	С	D	E		F	G	Н	I	J	К
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	Q	0	Ν	П

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Maximum Ratings ($@T_A = +25^{\circ}C$, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _{RM}	40	V
RMS Reverse Voltage	V _{R(RMS)}	28	V
Average Rectified Output Current (See Figure 1)	lo	2.0	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}	50	A
Repetitive Peak Avalanche Power (1µs, +25°C)	PARM	6,000	W

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Maximum Thermal Resistance			
Thermal Resistance Junction to Soldering (Note 7)	R ₀ JS	5	
Thermal Resistance Junction to Ambient (Note 8)	$R_{\theta JA}$	180	°C/W
Thermal Resistance Junction to Ambient (Note 9)	$R_{\theta JA}$	115	
Thermal Resistance Junction to Lead (Note 8)	R _θ JL	60	
Operating and Storage Temperature Range	TJ, TSTG	-65 to +150	°C

Electrical Characteristics (@T_A = +25°C unless otherwise specified.)

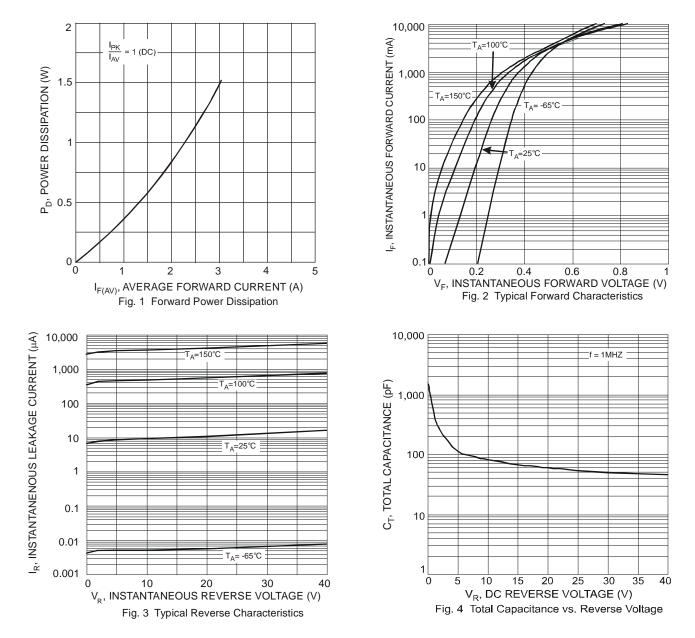
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage	V _{(BR)R}	40	-	-	V	I _R = 100μΑ
		-	0.265	0.315		I _F = 0.1A, T _J = +25°C
		-	0.38	0.43	- V	I _F = 1.0A, T _J = +25°C
Converd Veltege Drep	N/	-	0.45	0.50		I _F = 2.0A, T _J = +25°C
Forward Voltage Drop	V _F	-	0.17	0.22		I _F = 0.1A, T _J = +125°C
		-	0.325	0.375		I _F = 1.0A, T _J = +125°C
		-	0.42	0.47		I _F = 2.0A, T _J = +125°C
		-	8	40	μA	$V_R = 5V, T_J = +25^{\circ}C$
Lookage Current (Note 10)		-	16	100	μA	V _R = 40V, T _J = +25°C
Leakage Current (Note 10)	IR	-	1.3	8	mA	V _R = 5V, T _J = +125°C
		-	2.1	10	mA	V _R = 40V, T _J = +125°C

Notes:

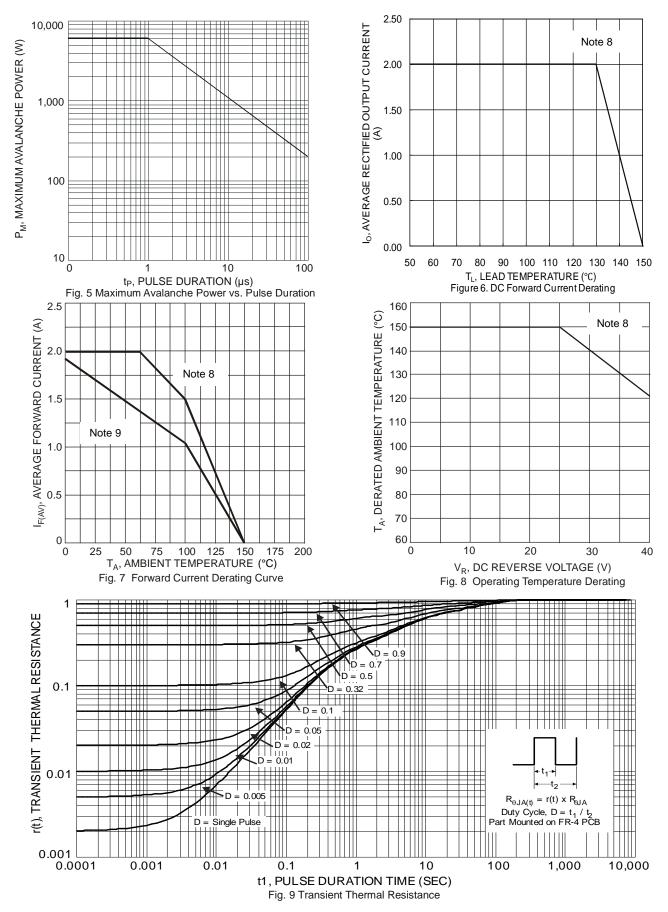
Theoretical R_{0JS} calculated from the top center of the die straight down to the PCB cathode tab solder junction.
FR-4 PCB, 2 oz. Copper, minimum recommended pad layout per http://www.diodes.com/package-outlines.html.
Polymide PCB, 2 oz. Copper, minimum recommended pad layout per http://www.diodes.com/package-outlines.html.
Short duration pulse test used to minimize self-heating effect.



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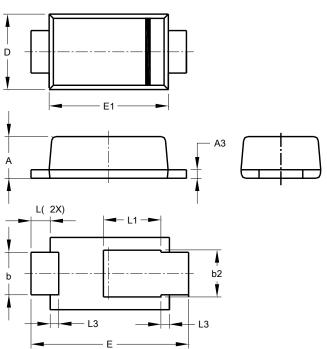






Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

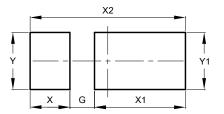


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PowerDI123							
Dim	Dim Min Max Typ						
Α	0.93	1.00	0.98				
A3	0.15	0.25	0.20				
b	0.85	1.25	1.00				
b2	1.025	1.125	1.10				
D	1.63	1.93	1.78				
ш	3.50	3.90	3.70				
E1	2.60	3.00	2.80				
L	0.40	0.50	0.45				
L1	1.25	1.40	1.35				
L3	0.125	0.275	0.20				
All	All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI123



Dimensions	Value (in mm)
G	0.65
Х	1.05
X1	2.40
X2	4.10
Y	1.50
Y1	1.50

PowerDI123



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